

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Harald Bottner et al.

Application No.: 10/789,423

Confirmation No.: 5684

Filed: February 27, 2004

Art Unit: 2826

For: SOLDER, MICROELECTROMECHANICAL
COMPONENT AND DEVICE, AND A
PROCESS FOR PRODUCING A
COMPONENT OR DEVICE

Examiner: B. P. Sandvik

SUBMISSION WITH REQUEST FOR CONTINUED EXAMINATION (RCE)

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated September 11, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.